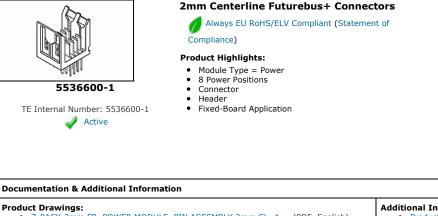


## 5536600-1 Product Details



Z-PACK 2mm FB, POWER MODULE, PIN ASSEMBLY 2mm CL, 4 ... (PDF, English)

Product Features (Please use the Product Drawing for all design activity)

Catalog Pages/Data Sheets: POWER\_CONNECTORS\_CATALOG\_SEC01\_BOARD\_TO\_BOARD (PDF, English)

## Product Specifications:

None Available

- **Application Specifications:** 
  - None Available

## Instruction Sheets: None Available

CAD Files: (CAD Format & Compression Information)

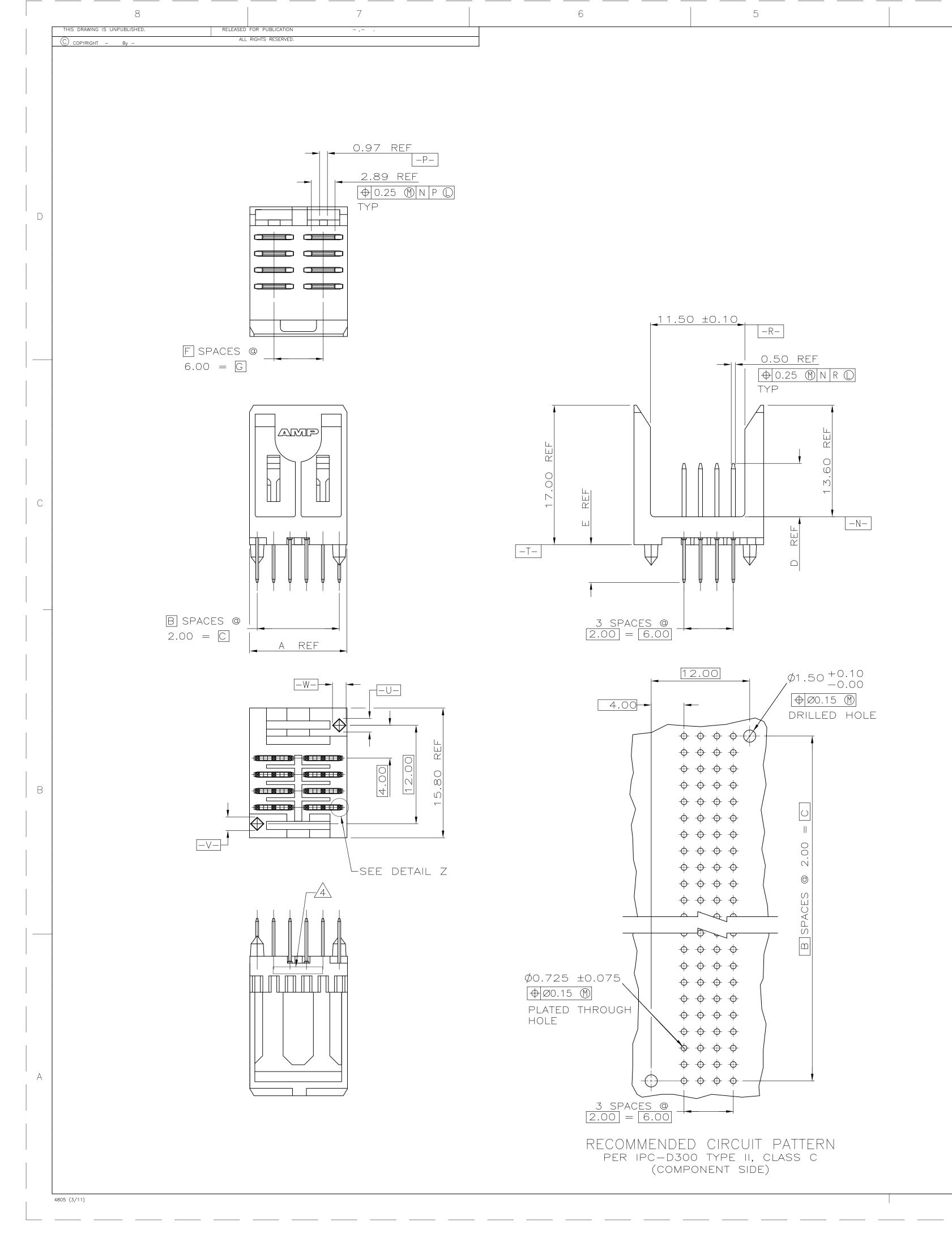
- 2D Drawing (DXF, Version O)
- 3D Model (IGES, Version O)
- 3D Model (STEP, Version O)

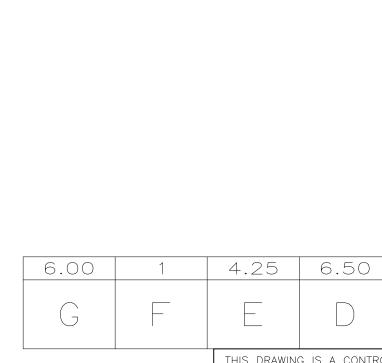
## Additional Information:

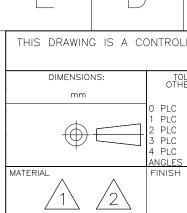
Product Line Information

**Related Products:** Tooling

**Product Type Features: Housing Features:**  Module Type = Power Connector Style = Plug • Product Type = Connector Centerline, Matrix (mm [in]) = 2.00 x 2.00 [.079 x .079] • Connector Type = Header • Housing Material = Liquid Crystal Polymer (LCP) • PCB Mounting Orientation = Vertical **Configuration Features:** • Post Type = Solder Post Number of Power Positions = 8 Make First / Break Last = No • Number of Rows = 4 **Electrical Characteristics:** Industry Standards: Voltage Rating (VAC) = 30 RoHS/ELV Compliance = RoHS compliant, ELV compliant Lead Free Solder Processes = Wave solder capable to 240°C, **Termination Features:** Wave solder capable to 260°C, Wave solder capable to 265°C, Reflow solder capable to 245°C, Reflow solder capable to 260°C, Pin-in-Paste capable to 245°C, Pin-in-Paste capable to • Termination Post Length (mm [in]) = 4.25 [0.167] Dimensions: 260°C Mating Post Length (mm [in]) = 6.50 [0.256] • RoHS/ELV Compliance History = Always was RoHS compliant • Pin Header Width (mm [in]) = 16.00 [0.622] Conditions for Usage: **Body Features:** • Applies To = Printed Circuit Board Sequencing = No • Post Plating = Tin **Operation/Application:** Application = Fixed-Board **Contact Features:**  Contact Type = Pin Other: • Contact Base Material = Phosphor Bronze Brand = AMP Contact Plating, Mating Area, Material = Gold (30) .







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1 HOUSING MATERIAL: LIQUID CRYSTAL POLY CONTACT MATERIAL: PHOSPHOR BRONZE PI

CONTACT FINISH:(E)

UNDERPLATE (ENTIRE CONTACT):

0.00127 MIN NICKEL PER SAE-AMS ON MATING SURFACES:

FLASH GOLD PER ASTM B 488, OVE 0.00076 MIN PALLADIUM-NICKEL ON 0.00076 MIN GOLD PER ASTM B 48

ON LEADS: 0.00381 MIN MATTE TIN PER ASTM LUBRICATION (MIN MATING SURFACES) SURFACE CONDITIONER AFTER PLATI

A PART MARKING, LOCATED APPROXIMATELY

0.51 ±0.07

DETAIL Z

SCALE 20:1

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